

**Vishay Siliconix** 

RoHS COMPLIANT

# **Bi-Directional N-Channel 30-V (D-S) MOSFET**

PRODUCT SUMMARY				
V <sub>S1S2</sub> (V)	<b>R<sub>S1S2(on)</sub> (</b> Ω)	I <sub>S1S2</sub> (A)		
30	0.045 at V <sub>GS</sub> = 4.5 V	4.9		
	0.060 at $V_{GS}$ = 2.5 V	4.2		

#### FEATURES

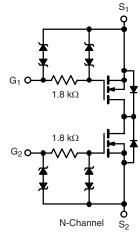
- TrenchFET<sup>®</sup> Power MOSFET
- Ultra-Low  $R_{SS(on)}$  and 22.5  $m\Omega$  Maximum Effective On-Resistance
- ESD Protected: 4000 V
- MICRO FOOT<sup>®</sup> Chipscale Packaging Reduces Footprint Area, Profile (0.65 mm) and On-Resistance Per Footprint Area

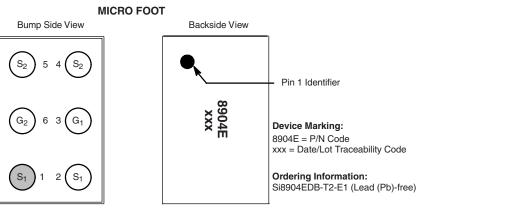
#### **APPLICATIONS**

Battery Protection Circuit

 1-2 Cell Li+/LiP Battery

 Pack for Portable Devices





Parameter		Symbol	5 s	Steady State	Unit
Source1- Source2 Voltage		V <sub>S1S2</sub>	30		V
Gate-Source Voltage		V <sub>GS</sub>	± 12		
	T <sub>A</sub> = 25 °C		4.9	3.8	А
Continuous Source1- Source2 Current $(T_J = 150 \text{ °C})^a$	T <sub>A</sub> = 85 °C	I <sub>S1S2</sub>	3.5	2.7	
Pulsed Source1- Source2 Current		I <sub>SM</sub>	25		
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	1.7	1	W
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 85 °C	۲D	0.8	0.5	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C
Package Reflow Conditions <sup>c</sup>	IR/Convection		260		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum lunction to Ambienta	t ≤ 5 s	R <sub>thJA</sub>	60	75	
Maximum Junction-to-Ambient <sup>a</sup>	Steady State	<sup>rn</sup> thJA	95	120	°C/W
Maximum Junction-to-Foot <sup>b</sup>	Steady State	R <sub>thJF</sub>	18	22	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. The foot is defined as the top surface of the package.

c. Refer to IPC/JEDEC (J-STD-020C), no manual or hand soldering.

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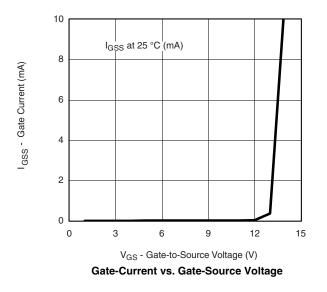
<b>SPECIFICATIONS</b> $T_J = 25 \text{ °C}$ , unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V <sub>GS(th)</sub>	(th) $V_{SS} = V_{GS}, I_D = 250 \mu\text{A}$			1.6	V	
Gate-Body Leakage	lasa	$V_{SS} = 0 V, V_{GS} = \pm 4.5 V$			± 4	μA	
	IGSS	$V_{SS} = 0 V, V_{GS} = \pm 12 V$			± 10	mA	
Zero Gate Voltage Source Current	1	$V_{SS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1		
	I <sub>S1S2</sub>	$V_{SS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 85 ^{\circ}\text{C}$			5	μA	
On-State Source Current <sup>a</sup>	I <sub>S(on)</sub>	$V_{SS} = 5 V, V_{GS} = 4.5 V$	5			А	
	a R <sub>S1S2(on)</sub>	$V_{GS} = 4.5 \text{ V}, \text{ I}_{SS} = 1 \text{ A}$		0.037	0.045	(	
Source1- Source2 On-State Resistance <sup>a</sup>		V <sub>GS</sub> = 2.5 V, I <sub>SS</sub> = 1 A 0.048		0.048	0.060	Ω	
Forward Transconductance <sup>a</sup> g <sub>fs</sub>		$V_{SS} = 10 \text{ V}, \text{ I}_{SS} = 1 \text{ A}$		12		S	
Dynamic <sup>b</sup>							
Turn-On Delay Time	t <sub>d(on)</sub>			1.6	2.4		
Rise Time	t <sub>r</sub>	$V_{SS}$ = 10 V, $R_L$ = 10 $\Omega$		2	3	μs	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_{SS}\cong$ 1 A, $V_{GEN}$ = 4.5 V, $R_g$ = 6 $\Omega$		1.5	2.3		
Fall Time t <sub>f</sub>				3.7	5.6	1	

Notes:

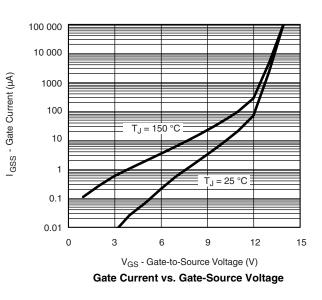
a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

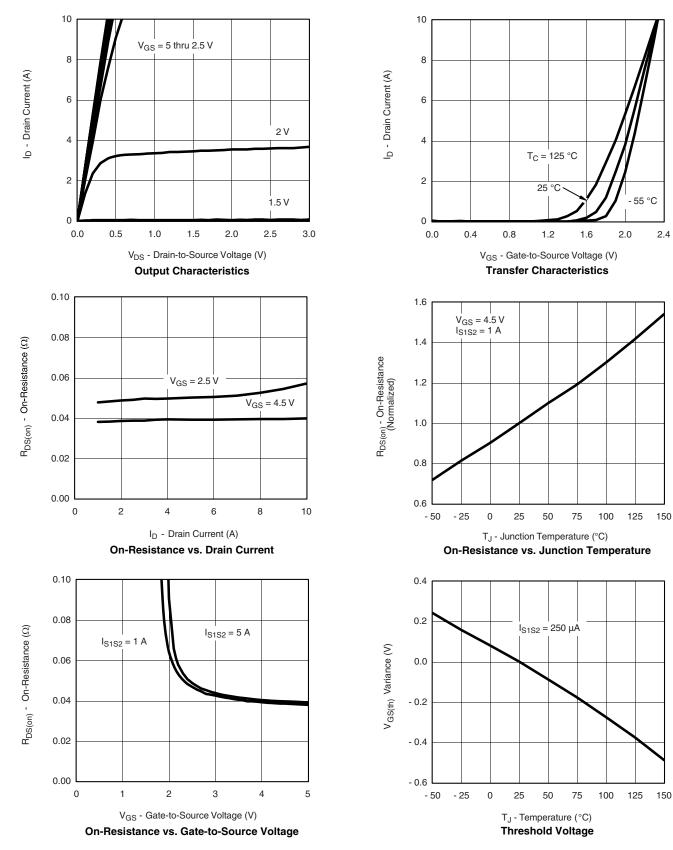




# Si8904EDB

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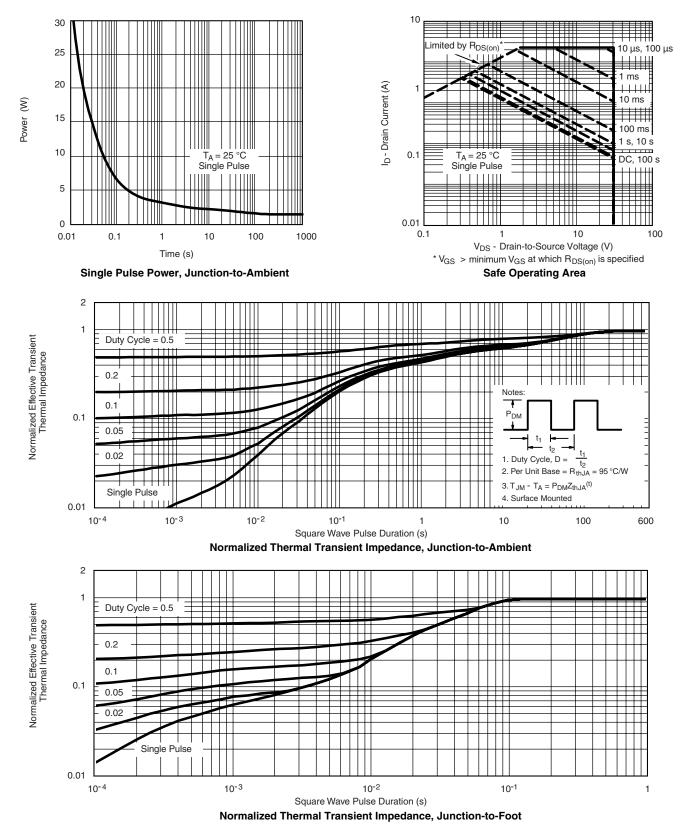
Document Number: 72948 S-82119-Rev. C, 08-Sep-08

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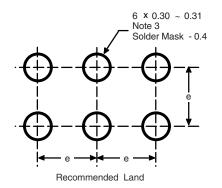
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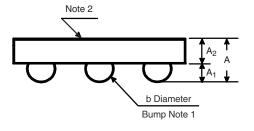




#### PACKAGE OUTLINE

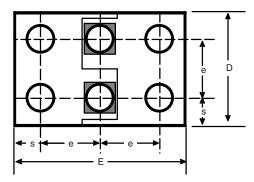
#### MICRO FOOT: 6-BUMP (2 x 3, 0.8 mm PITCH)







Mark on Backside of Die



Notes (Unless Otherwise Specified):

1. 6 solder bumps are 95.5/3.8/0.7 Sn/Ag/Cu.

2. Backside surface is coated with a Ag/Ni/Ti layer.

3. Non-solder mask defined copper landing pad.

4. Laser marks on the silicon die back.

Dim.	Millin	neters <sup>a</sup>	Inches		
	Min.	Max.	Min.	Max.	
Α	0.600	0.650	0.0236	0.0256	
A <sub>1</sub>	0.260	0.290	0.102	0.114	
A <sub>2</sub>	0.340	0.360	0.0134	0.0142	
b	0.370	0.410	0.0146	0.0161	
D	1.520	1.600	0.0598	0.0630	
E	2.320	2.400	0.0913	0.0945	
е	0.750	0.850	0.0295	0.0335	
s	0.380	0.400	0.0150	0.0157	

Notes:

a. Use millimeters as the primary measurement.

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